

EXHIBIT S

UNITED STATES DISTRICT COURT
FOR THE EASTERN DISTRICT OF TEXAS
MARSHALL DIVISION

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NETLIST, INC.,)
Plaintiff.)
vs.) Case No.
MICRON TECHNOLOGY, INC.;) 2:22-cv-203-JRG-RSP
MICRON SEMICONDUCTOR)
PRODUCTS, INC.; MICRON)
TECHNOLOGY TEXAS LLC,)
Defendants.)
_____)

VIDEOTAPED DEPOSITION OF HAROLD STONE, Ph.D.
REMOTE PROCEEDINGS
MONDAY, JUNE 26, 2023

STENOGRAPHICALLY REPORTED BY:
ANDREA M. IGNACIO, CSR, RPR, CRR, CCRR, CLR ~ CSR
LICENSE NO. 9830
JOB NO. 5968770

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1 you what's happening. Look at Figure 2.20, page 79. 13:39
2 Okay. On this page, a wave is sent from the left 13:39
3 where there -- you see the Z0, and it goes out to 13:39
4 where there's a junction. At the junction, it's 13:39
5 reflected back, and part of the wave goes forward 13:39
6 straight; part of it goes to the left. That's what 13:40
7 you're dealing with with physics. 13:40

8 And that happens when you're connected to the 13:40
9 die, regardless of what happens on the die, whether 13:40
10 there is a port array connected to it or not. 13:40

11 So what happens is that the wave propagates 13:40
12 on the die along the stub or to the port array, and it 13:40
13 bounces back again. So those waves are going back and 13:40
14 forth and back and forth, and that's what causes the 13:40
15 noise that you saw in the earlier figure. 13:40

16 Let me go back to 2.19. Do you see that 13:40
17 noise there? Each bump or change is a result of a 13:40
18 reflection, and the reflections come from the port 13:40
19 arrays, the data arrays on the ports. They also come 13:40
20 from the stubs if they don't have a data port 13:40
21 connected, and they come from the points where there's 13:40
22 a branch. 13:41

23 So changing things by removing or adding 13:41
24 devices only changes the noise, unless you don't have 13:41
25 a multi -- unless there are no stubs or no drivers. 13:41

1 Then you -- then you can get a predictable wave. And 13:41
2 that has -- that even has reflections, but it looks 13:41
3 different. 13:41
4 So that's my testimony. 13:41
5 Q Okay. Let me see if I understand something. 13:41
6 Is it your testimony that the connection 13:41
7 between a TSV and a stub is electrical communication? 13:41
8 A Yeah. This demonstrates it, because the wave 13:41
9 travels on that. 13:41
10 Q Okay. What does the word "electrical 13:41
11 communication" mean to you? 13:41
12 A Electrical connection. That's -- I got that 13:41
13 from the patent. I can show you where he says that. 13:41
14 Q Okay. Show me. 13:41
15 A Okay. The patent -- the -- is what exhibit? 13:41
16 Q Exhibit 9, sir. 13:42
17 A Okay. I'll open the Exhibit 9. 13:42
18 So I have the '060 patent up. I'll -- I will 13:42
19 find that reference that says that it connects -- 13:42
20 makes the association between electrical communication 13:43
21 and electrical connection. 13:43
22 I would like you to look at column 17. 13:43
23 Q Okay. I'm there. 13:43
24 A I'm looking at line 65. Line 65 reads: 13:43
25 "Forming the electrical connections places 13:43

1 the die interconnects in" -- "communication with the 13:43
2 respective drivers." 13:44
3 Okay. Now, let's see. There may be 13:44
4 additional I would like to look at. Now, continuing 13:44
5 on from that point, it says: 13:44
6 "In some embodiments, forming the electrical 13:44
7 connections can comprise forming electrical 13:44
8 connections between the die interconnects and a data 13:44
9 conduit." 13:44
10 Okay. 13:44
11 Q I'm sorry to interrupt, but can I ask a 13:44
12 clarifying question? 13:44
13 A And see, that -- that -- well, actually, 13:44
14 that's not so relevant. It's the previous sentence 13:44
15 that I read: 13:44
16 "Forming the electrical connections places 13:44
17 the die interconnects in electrical communication with 13:44
18 the respective drivers." 13:44
19 So what we've done is we -- if you connect a 13:44
20 die interconnect to a -- one of the levels in the 13:45
21 figure, you now are connecting to some conductor. 13:45
22 That conductor will carry a wave when you -- when you 13:45
23 drive it. It has capacitance. It has a load. 13:45
24 And whether or not that conductor is -- is 13:45
25 attached to a data port, you will see the wave go down 13:45

1 that conductor. At the end, it will bounce -- bounce 13:45
2 back, and you'll see that as noise. Moreover, the 13:45
3 capacitance on the conductor will load the driver. 13:45

4 So in every way, forming the electrical 13:45
5 connection and placing this piece of a -- of a metal 13:45
6 on the -- on an array, it will form to an electrical 13:45
7 communication. That's what you'll get. Electrical 13:45
8 connection is electrical communication in this sense. 13:45

9 Q Okay. But can I ask a clarifying question? 13:46

10 So on line 65, column 17, it says: 13:46

11 "Forming the electrical connection places the 13:46
12 die interconnects in electrical communication with the 13:46
13 respective drivers." 13:46

14 Right? 13:46

15 That's talking about the drivers on the 13:46
16 control die; right? 13:46

17 A That's correct. 13:46

18 Q Okay. So it's not talking about electrical 13:46
19 communication with the array dies; right? 13:46

20 A No. I disagree. 13:46

21 Q Why? 13:46

22 A You -- you will understand that the VIA is 13:46
23 now connected to the -- to the array die, because 13:46
24 there may be metal there. There may be a metal -- a 13:46
25 metal pathway. 13:46

1 Q I understand. 13:46

2 But you're saying that this specific 13:46

3 disclosure that equates electrical connection with 13:46

4 electrical communication discusses array dies. 13:46

5 And I'm pointing out to you that it 13:46

6 specifically says drivers, and these are drivers in 13:46

7 the control die; right? 13:47

8 A Yeah, but that's fine. The driver is in 13:47

9 communication with whatever the -- the VIA is 13:47

10 connected to on that die. 13:47

11 Q Does the passage mention electrical 13:47

12 communication with array dies? 13:47

13 MR. RUECKHEIM: Object to the form. 13:47

14 THE WITNESS: Does the -- it just -- it just 13:47

15 did. That's what it says. 13:47

16 MR. TEZYAN: Q. Where does it say "array 13:47

17 die" in this paragraph, sir? 13:47

18 A Just a moment. 13:47

19 Okay. There is a reference to this in 13:48

20 column 8 at line 57. 13:48

21 Q And I don't mean to cut you off, sir, but the 13:48

22 question was about paragraph -- the paragraph starting 13:48

23 on line 60 of column 17. 13:48

24 And the question was: Where in that 13:48

25 paragraph that you claim provides support for your 13:48

1 but long answer, is it your testimony that the driver 15:47
2 size doesn't depend on how many transistors are 15:48
3 actively being used? 15:48

4 A The driver size in this patent is taught to 15:48
5 be the area of the driver or the physical dimensions 15:48
6 of the driver. And so it does not depend on the 15:48
7 number of transistors that are actually being used. 15:48

8 Q Okay. So if only two of the ten transistors 15:48
9 are used to drive a load, is the physical size of the 15:48
10 driver determined by the ten transistors or the two 15:48
11 transistors? 15:48

12 A Are you saying that you'll never use 15:48
13 transistors? Is that your assumption? 15:48

14 Q No. 15:48

15 I'm just saying for purposes of my 15:48
16 hypothetical, right, you have a driver that's composed 15:48
17 of ten transistors; right? 15:48

18 A I understand. 15:48

19 Q Okay. And for the particular load that's on 15:48
20 this driver, you're using two of the ten transistors 15:49
21 for driving. 15:49

22 Does that make sense? 15:49

23 A That makes sense. 15:49

24 Q Okay. So if only two of the ten transistors 15:49
25 are used to drive a load, is the physical size of the 15:49

1 driver determined by the ten transistors or the two 15:49
2 transistors? 15:49
3 A I asked a question: Do you ever turn on all 15:49
4 ten transistors? 15:49
5 Q You could. But in this situation, you're 15:49
6 just using two. 15:49
7 A I think you answered my question. If you can 15:49
8 turn on all ten, the driver size is related to the 15:49
9 load that you can drive. And if you're going to drive 15:49
10 ten transistors, you have to have enough area to 15:49
11 dissipate the power they generate. And once you have 15:49
12 that area, even if you only use two, you've got the 15:49
13 area, because you're committed to the area for the 15:49
14 ten. 15:49
15 Q Okay. So the answer to my question is that 15:49
16 if you have a driver that's composed of ten 15:49
17 transistors, regardless of whether you're driving two 15:49
18 or ten of them, the driver size is ten transistors? 15:50
19 A No. The driver size is the physical 15:50
20 dimension of the driver. 15:50
21 Q Okay. Sorry. I withdraw the question. 15:50
22 So let me just ask the original question 15:50
23 again: If only two of the ten transistors are used to 15:50
24 drive a load, is the physical size of the driver 15:50
25 determined by the ten transistors? 15:50

1 A I don't know exactly, but the answer is it 15:50
2 could be. 15:50
3 Q Okay. When would it not be determined by 15:50
4 those ten transistors? 15:50
5 A Ask your question again, because I think I 15:50
6 misunderstood it. 15:50
7 Q Sure. 15:50
8 The -- the question is -- and I think I know 15:50
9 the answer, based on your testimony, but I just want 15:50
10 to make sure we're absolutely clear. 15:50
11 So if only two of the ten transistors are 15:50
12 used to drive a load, is the physical size of the 15:50
13 drive -- the driver determined by ten transistors or 15:51
14 two transistors? 15:51
15 A My answer is going to be determined by the 15:51
16 two transistors, because the size of the driver has to 15:51
17 be able to dissipate the power of whatever is in 15:51
18 there. And if those two transistors are driving like 15:51
19 mad, and that would -- might be the case, then you 15:51
20 have to make enough area to dissipate the heat. 15:51
21 You just told me that you're never going to 15:51
22 drive the other eight, if I understand the hypothesis. 15:51
23 Q No. 15:51
24 So -- 15:51
25 A Okay. 15:51

CERTIFICATE OF STENOGRAPHIC REPORTER

I, ANDREA M. IGNACIO, hereby certify that the witness in the foregoing remote deposition was by me sworn to tell the truth, the whole truth, and nothing but the truth in the within-entitled cause;

That said remote deposition was taken in shorthand by me, a disinterested person, at the time and place therein stated, and that the testimony of the said witness was thereafter reduced to typewriting, by computer, under my direction and supervision;

That before completion of the deposition, review of the transcript [] was [x] was not requested. If requested, any changes made by the deponent (and provided to the reporter) during the period allowed are appended hereto.

I further certify that I am not of counsel or attorney for either or any of the parties to the said deposition, nor in any way interested in the event of this cause, and that I am not related to any of the parties thereto.

Dated: June 27, 2023

A handwritten signature in blue ink, appearing to read 'Andrea M. Ignacio', is written over a horizontal line.

ANDREA M. IGNACIO, RPR, CRR, CCRR, CLR, CSR No. 9830